# DATA SHEET WWW.DZSC.COM **PCA9544A** 4-channel I<sup>2</sup>C multiplexer with interrupt logic

**INTEGRATED CIRCUITS** 

Product data sheet Supersedes data of 2004 Jul 28 2004 Sep 29







# **PCA9544A**



#### **FEATURES**

- 1-of-4 bi-directional translating multiplexer
- I<sup>2</sup>C interface logic; compatible with SMBus
- 4 Active-LOW Interrupt Inputs
- Active-LOW Interrupt Output
- 3 address pins allowing up to 8 devices on the I<sup>2</sup>C-bus
- Channel selection via I<sup>2</sup>C-bus
- Power-up with all multiplexer channels deselected
- Low Rds<sub>ON</sub> switches
- $\bullet$  Allows voltage level translation between 1.8 V, 2.5 V, 3.3 V and 5 V buses
- No glitch on power-up
- Supports hot insertion
- Low stand-by current
- Operating power supply voltage range of 2.3 V to 5.5 V
- 5 V tolerant Inputs
- 0 to 400 kHz clock frequency
- ESD protection exceeds 2000 V HBM per JESD22-A114, 200 V MM per JESD22-A115 and 1000 V per JESD22-C101
- Latchup testing is done to JESDEC Standard JESD78 which exceeds 100 mA
- Three packages offered: SO20, TSSOP20, and HVQFN20

## **ORDERING INFORMATION**

PACKAGES	TEMPERATURE RANGE	ORDER CODE	TOPSIDE MARK	DRAWING NUMBER
20-Pin Plastic SO	–40 °C to +85 °C	PCA9544AD	PCA9544AD	SOT163-1
20-Pin Plastic TSSOP	–40 °C to +85 °C	PCA9544APW	PA9544A	SOT360-1
20-Pin Plastic HVQFN	−40 °C to +85 °C	PCA9544ABS	9544A	SOT662-1

Standard packing quantities and other packaging data are available at www.standardproducts.philips.com/packaging. I<sup>2</sup>C is a trademark of Philips Semiconductors Corporation.

#### DESCRIPTION

The PCA9544A is a 1-of-4 bi-directional translating multiplexer, controlled via the I<sup>2</sup>C-bus. The SCL/SDA upstream pair fans out to four SCx/SDx downstream pairs, or channels. Only one SCx/SDx channel is selected at a time, determined by the contents of the programmable control register. Four interrupt inputs, INT0 to INT3, one for each of the SCx/SDx downstream pairs, are provided. One interrupt output, INT, which acts as an AND of the four interrupt inputs, is provided.

A power-on reset function puts the registers in their default state and initializes the  $l^2C$  state machine with no channels selected.

The pass gates of the multiplexer are constructed such that the  $V_{DD}$  pin can be used to limit the maximum high voltage which will be passed by the PCA9544A. This allows the use of different bus voltages on each SCx/SDx pair, so that 1.8 V, 2.5 V or 3.3 V parts can communicate with 5 V parts without any additional protection. External pull-up resistors pull the bus up to the desired voltage level for each channel. All I/O pins are 5 V tolerant.

## PCA9544A

## PIN CONFIGURATION — SO, TSSOP

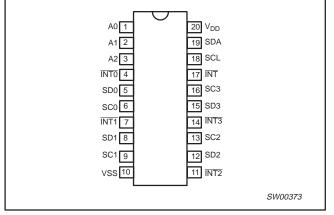


Figure 1. Pin configuration — SO, TSSOP

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## **PIN DESCRIPTION**

20

#### SO, TSSOP HVQFN SYMBOL FUNCTION PIN NUMBER **PIN NUMBER** 19 A0 Address input 0 1 2 20 A1 Address input 1 3 A2 Address input 2 1 4 2 INTO Active-LOW interrupt input 0 5 3 SD0 Serial data 0 SC0 Serial clock 0 6 4 7 5 INT1 Active-LOW interrupt input 1 8 6 SD1 Serial data 1 Serial clock 1 9 7 SC1 10 8 $V_{SS}$ Supply ground 9 INT2 Active-LOW interrupt input 2 11 12 10 SD2 Serial data 2 SC2 13 11 Serial clock 2 12 INT3 14 Active-LOW interrupt input 3 15 13 SD3 Serial data 3 16 14 SC3 Serial clock 3 17 15 INT Active-LOW interrupt output 16 SCL Serial clock line 18 SDA 19 17 Serial data line

 $V_{DD}$ 

Supply voltage

## PIN CONFIGURATION — HVQFN

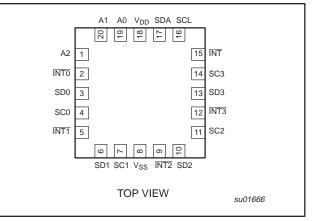


Figure 2. Pin configuration — HVQFN

## **BLOCK DIAGRAM**

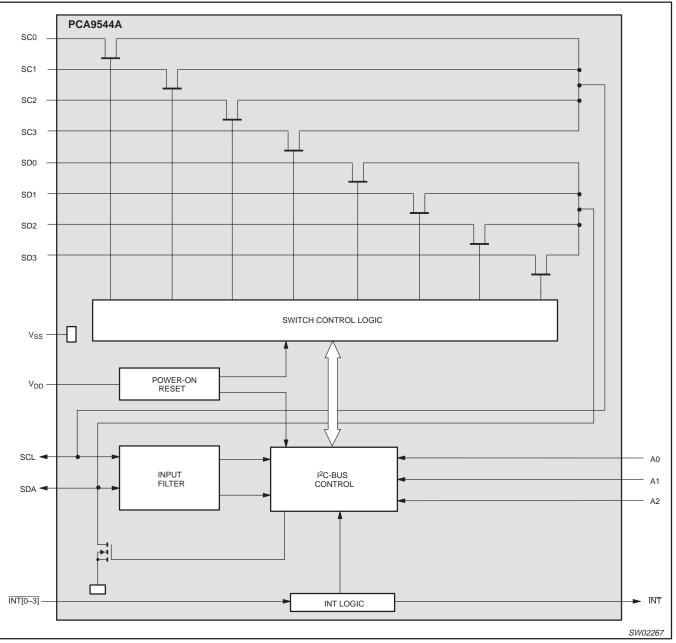


Figure 3. Block diagram

## PCA9544A

## **DEVICE ADDRESSING**

Following a START condition the bus master must output the address of the slave it is accessing. The address of the PCA9544A is shown in Figure 4. To conserve power, no internal pull-up resistors are incorporated on the hardware selectable address pins and they must be pulled HIGH or LOW.

1	1	1	1	0	A2	A1	A0	R/W
					~	~		
		FĽ	XED		HA	RDV	VARE	SELE

Figure 4. Slave address

The last bit of the slave address defines the operation to be performed. When set to logic 1, a read is selected while a logic 0 selects a write operation.

## **CONTROL REGISTER**

Following the successful acknowledgement of the slave address, the bus master will send a byte to the PCA9544A which will be stored in the Control Register. If multiple bytes are received by the PCA9544A, it will save the last byte received. This register can be written and read via the  $l^2$ C-bus.

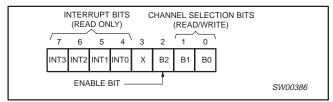


Figure 5. Control register

## **CONTROL REGISTER DEFINITION**

A SCx/SDx downstream pair, or channel, is selected by the contents of the control register. This register is written after the PCA9544A has been addressed. The 3 LSBs of the control byte are used to determine which channel is to be selected. When a channel is selected, it will become active after a stop condition has been placed on the I<sup>2</sup>C-bus. This ensures that all SCx/SDx lines will be in a HIGH state when the channel is made active, so that no false conditions are generated at the time of connection.

#### Table 1. Control Register; Write — Channel Selection/ Read — Channel Status

INT3	INT2	INT1	INT0	D3	B2	B1	B0	COMMAND
Х	Х	Х	Х	Х	0	Х	Х	No channel selected
Х	Х	Х	Х	Х	1	0	0	Channel 0 enabled
Х	Х	Х	Х	Х	1	0	1	Channel 1 enabled
Х	Х	Х	Х	Х	1	1	0	Channel 2 enabled
Х	Х	Х	Х	Х	1	1	1	Channel 3 enabled
0	0	0	0	0	0	0	0	No channel selected; power-up default state

## **INTERRUPT HANDLING**

The PCA9544A provides 4 interrupt inputs, one for each channel and one open drain interrupt output. When an interrupt is generated by any device, it will be detected by the PCA9544A and the interrupt output will be driven LOW. The channel need not be active for detection of the interrupt. A bit is also set in the control byte. Bits 4 - 7 of the control byte correspond to channels 0 - 3 of the PCA9544A, respectively. Therefore, if an interrupt is generated by any device connected to channel 2, the state of the interrupt inputs is loaded into the control register when a read is accomplished. Likewise, an interrupt on any device connected to channel 0 would cause bit 4 of the control register to be set on the read. The master can then address the PCA9544A and read the contents of the control byte to determine which channel contains the device generating the interrupt. The master can then reconfigure the PCA9544A to select this channel, and locate the device generating the interrupt and clear it. The interrupt clears when the device originating the interrupt clears.

It should be noted that more than one device can be providing an interrupt on a channel, so it is up to the master to ensure that all devices on a channel are interrogated for an interrupt.

The interrupt inputs may be used as general purpose inputs if the interrupt function is not required.

If unused, interrupt input(s) must be connected to  $\mathsf{V}_{\mathsf{D}\mathsf{D}}$  through a pull-up resistor.

INT3	INT2	INT1	INT0	D3	B2	B1	B0	COMMAND								
x	x	x	0	х	x	х	х	No interrupt on channel 0								
	Χ		1	$1^{^{^{^{^{^{^{^{^{^{^{^{^{^{^{^{^{^{^{$		~	Χ	Χ	Interrupt on channel 0							
x	x	0	x	х	x	x x	х	No interrupt on channel 1								
	Χ		^		~			Interrupt on channel 1								
x	0	x	x	x	x x	х	No interrupt on channel 2									
	1		^		^	^	^	^	~	^	^	^		^	~	~
0	x	x	x x		х	х	х	No interrupt on channel 3								
1			~	~	~	~		Interrupt on channel 3								

#### Table 2. Control Register Read — Interrupt

**NOTE:** Several interrupts can be active at the same time. Ex: INT3 = 0, INT2 = 1, INT1 = 1, INT0 = 0, means that there is no interrupt on channels 0 and 3, and there is interrupt on channels 1 and 2.

## **POWER-ON RESET**

When power is applied to V<sub>DD</sub>, an internal Power On Reset holds the PCA9544A in a reset condition until V<sub>DD</sub> has reached V<sub>POR</sub>. At this point, the reset condition is released and the PCA9544A registers and I<sup>2</sup>C state machine are initialized to their default states, all zeroes causing all the channels to be deselected. Thereafter, V<sub>DD</sub> must be lowered below 0.2 V to reset the device.

## PCA9544A

#### **VOLTAGE TRANSLATION**

The pass gate transistors of the PCA9544A are constructed such that the  $V_{DD}$  voltage can be used to limit the maximum voltage that will be passed from one I<sup>2</sup>C-bus to another.

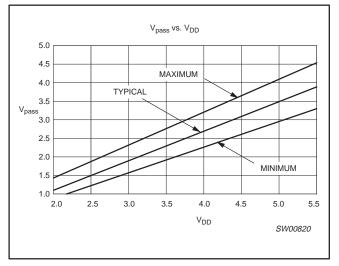


Figure 6. V<sub>pass</sub> voltage

Figure 6 shows the voltage characteristics of the pass gate transistors (note that the graph was generated using the data specified in the DC Characteristics section of this datasheet). In order for the PCA9544A to act as a voltage translator, the V<sub>pass</sub> voltage should be equal to, or lower than the lowest bus voltage. For example, if the main bus was running at 5 V, and the downstream buses were 3.3 V and 2.7 V, then V<sub>pass</sub> should be equal to or below 2.7 V to effectively clamp the downstream bus voltages. Looking at Figure 6, we see that V<sub>pass</sub> (max.) will be at 2.7 V when the PCA9544A supply voltage is 3.5 V or lower so the PCA9544A supply voltage to their appropriate levels (see Figure 13).

More Information can be found in Application Note AN262 *PCA954X* family of  $l^2C/SMBus$  multiplexers and switches.

# PCA9544A

## CHARACTERISTICS OF THE I<sup>2</sup>C-BUS

The I<sup>2</sup>C-bus is for 2-way, 2-line communication between different ICs or modules. The two lines are a serial data line (SDA) and a serial clock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor when connected to the output stages of a device. Data transfer may be initiated only when the bus is not busy.

## Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse as changes in the data line at this time will be interpreted as control signals (see Figure 7).

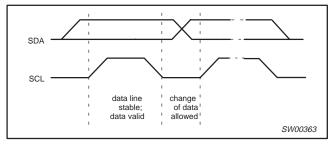


Figure 7. Bit transfer

## Start and stop conditions

Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW transition of the data line, while the clock is HIGH is defined as the start condition (S). A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the stop condition (P) (see Figure 8).

## System configuration

A device generating a message is a 'transmitter', a device receiving is the 'receiver'. The device that controls the message is the 'master' and the devices which are controlled by the master are the 'slaves' (see Figure 9).

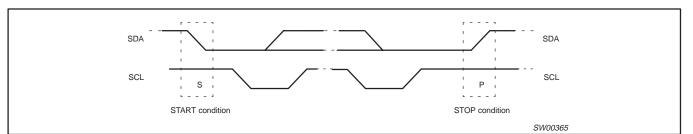


Figure 8. Definition of start and stop conditions

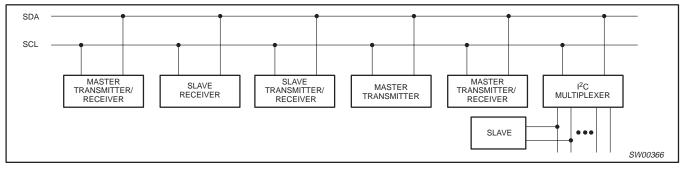


Figure 9. System configuration

## PCA9544A

## Acknowledge

The number of data bytes transferred between the start and the stop conditions from transmitter to receiver is not limited. Each byte of eight bits is followed by one acknowledge bit. The acknowledge bit is a HIGH level put on the bus by the transmitter whereas the master generates an extra acknowledge related clock pulse.

A slave receiver which is addressed must generate an acknowledge after the reception of each byte. Also a master must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter. The device that acknowledges has to pull down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse, set-up and hold times must be taken into account.

A master receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this event, the transmitter must leave the data line HIGH to enable the master to generate a stop condition.

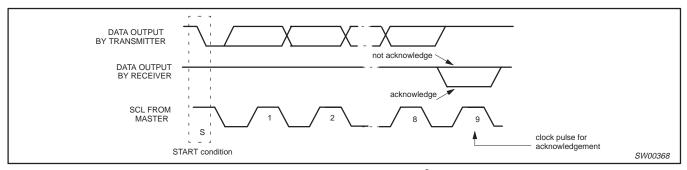


Figure 10. Acknowledgement on the I<sup>2</sup>C-bus

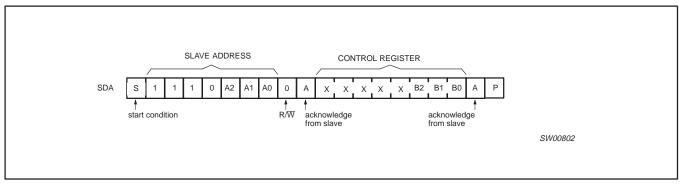


Figure 11. WRITE control register

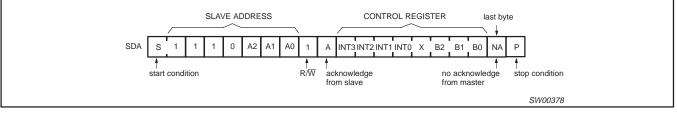
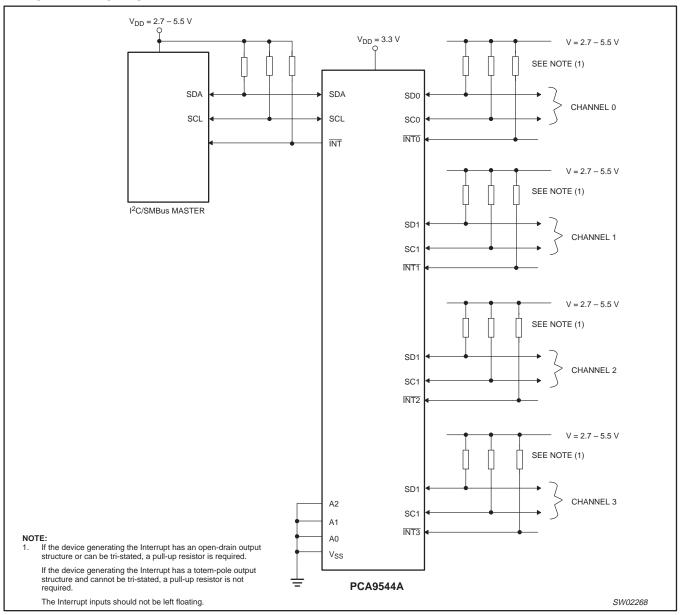


Figure 12. READ control register

# TYPICAL APPLICATION





## PCA9544A

## ABSOLUTE MAXIMUM RATINGS<sup>1, 2</sup>

In accordance with the Absolute Maximum Rating System (IEC 134). Voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V <sub>DD</sub>	DC supply voltage		-0.5 to +7.0	V
VI	DC input voltage		-0.5 to +7.0	V
l	DC input current		±20	mA
Ι <sub>Ο</sub>	DC output current		±25	mA
I <sub>DD</sub>	Supply current		±100	mA
I <sub>SS</sub>	Supply current		±100	mA
P <sub>tot</sub>	total power dissipation		400	mW
T <sub>stg</sub>	Storage temperature range		-60 to +150	°C
T <sub>amb</sub>	Operating ambient temperature		-40 to +85	°C

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the Stresses beyond those instearing cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
 The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.

## PCA9544A

## **DC CHARACTERISTICS**

 $V_{DD}$  = 2.3 V to 3.6 V;  $V_{SS}$  = 0 V;  $T_{amb}$  = -40 °C to +85 °C; unless otherwise specified. (See page 12 for  $V_{DD}$  = 3.6 V to 5.5 V)

	DADAMETED			LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT	
Supply					·		
V <sub>DD</sub>	Supply voltage		2.3	—	3.6	V	
I <sub>DD</sub>	Supply current	Operating mode; $V_{DD}$ = 3.6 V; no load; V <sub>I</sub> = V <sub>DD</sub> or V <sub>SS</sub> ; f <sub>SCL</sub> = 100 kHz	—	10	30	μA	
I <sub>stb</sub>	Standby current	Standby mode; $V_{DD}$ = 3.6 V; no load; V <sub>I</sub> = V <sub>DD</sub> or V <sub>SS</sub> ; f <sub>SCL</sub> = 0 kHz	—	0.1	1	μΑ	
V <sub>POR</sub>	Power-on reset voltage (Note 1)	no load; $V_I = V_{DD}$ or $V_{SS}$	_	1.5	2.1	V	
nput SCL;	input/output SDA	-			•		
V <sub>IL</sub>	LOW-level input voltage		-0.5	—	0.3V <sub>DD</sub>	V	
VIH	HIGH-level input voltage		0.7V <sub>DD</sub>	—	6	V	
		V <sub>OL</sub> = 0.4 V	3	7	—	mA	
IOL	LOW-level output current	V <sub>OL</sub> = 0.6 V	6	10	-	IIIA	
١L	Leakage current	$V_{I} = V_{DD} \text{ or } V_{SS}$	-1	—	+1	μΑ	
Ci	Input capacitance	V <sub>I</sub> = V <sub>SS</sub>	_	10	13	pF	
Select inpu	ts A0 to A2 / INTO to INT3	•		•	•		
VIL	LOW-level input voltage		-0.5		+0.3V <sub>DD</sub>	V	
VIH	HIGH-level input voltage		0.7V <sub>DD</sub>	—	V <sub>DD</sub> + 0.5	V	
ILI	Input leakage current	$V_{I} = V_{DD} \text{ or } V_{SS}$	-1	—	+1	μΑ	
Ci	Input capacitance	V <sub>I</sub> = V <sub>SS</sub>	—	1.6	3	pF	
Pass Gate	-	-					
P	Qualitative and interaction	$V_{CC}$ = 3.0 V to 3.6 V, $V_O$ = 0.4 V, $I_O$ = 15 mA	5	11	30		
R <sub>ON</sub>	Switch resistance	$V_{CC}$ = 2.3 V to 2.7 V, $V_O$ = 0.4V, $I_O$ = 10 mA	7	16	55	Ω	
		$V_{swin} = V_{DD} = 3.3 \text{ V}; I_{swout} = -100 \mu\text{A}$	_	1.9	-		
	Outlink and and and and	$V_{swin} = V_{DD} = 3.0 \text{ V to } 3.6 \text{ V; } I_{swout} = -100  \mu\text{A}$	1.6	— —	2.8		
V <sub>Pass</sub>	Switch output voltage	$V_{swin} = V_{DD} = 2.5 \text{ V}; I_{swout} = -100 \mu\text{A}$	_	1.5		V	
		$V_{swin} = V_{DD} = 2.3 \text{ V to } 2.7 \text{ V; } I_{swout} = -100 \mu\text{A}$	1.1	-	2.0	1	
١L	Leakage current	$V_{I} = V_{DD} \text{ or } V_{SS}$	-1	- 1	+1	μΑ	
C <sub>io</sub>	Input/output capacitance	$V_{I} = V_{SS}$	_	3	5	pF	
NT Output	•	-		-		-	
I <sub>OL</sub>	LOW-level output current	V <sub>OL</sub> = 0.4 V	3	7	-	mA	
I <sub>OH</sub>	HIGH-level output current		_	—	+10	μA	

NOTES:

V<sub>DD</sub> must be lowered to 0.2 V in order to reset part.
 For operation between published voltage ranges, refer to worst case parameter in both ranges.

## PCA9544A

## **DC CHARACTERISTICS**

 $V_{DD}$  = 4.5 V to 5.5 V;  $V_{SS}$  = 0 V;  $T_{amb}$  = -40 °C to +85 °C; unless otherwise specified. (See page 11 for  $V_{DD}$  = 2.3 V to 3.6 V)

SYMBOL		TEST CONDITIONS		<b>-</b>		
STMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Supply	•	•				
V <sub>DD</sub>	Supply voltage		4.5	—	5.5	V
I <sub>DD</sub>	Supply current	Operating mode; $V_{DD} = 5.5 V$ ; no load; $V_I = V_{DD}$ or $V_{SS}$ ; $f_{SCL} = 100 \text{ kHz}$	_	25	100	μA
I <sub>stb</sub>	Standby current	Standby mode; $V_{DD}$ = 5.5 V; no load; $V_I$ = $V_{DD}$ or $V_{SS}$ ; $f_{SCL}$ = 0 kHz	_	0.3	1	μΑ
V <sub>POR</sub>	Power-on reset voltage	no load; $V_I = V_{DD}$ or $V_{SS}$	—	1.7	2.1	V
Input SCL;	input/output SDA					
V <sub>IL</sub>	LOW-level input voltage		-0.5	—	0.3V <sub>DD</sub>	V
V <sub>IH</sub>	HIGH-level input voltage		0.7V <sub>DD</sub>	—	6	V
	LOW-level output current	V <sub>OL</sub> = 0.4 V	3	—	-	mA
IOL		V <sub>OL</sub> = 0.6 V	6	— —	-	mA
١L	Leakage current	$V_{I} = V_{DD} \text{ or } V_{SS}$	-1	-	+1	μA
Ci	Input capacitance	$V_I = V_{SS}$	—	12	13	pF
Select inpu	ts A0 to A2 / INT0 to INT3	•			•	
V <sub>IL</sub>	LOW-level input voltage		-0.5	—	+0.3V <sub>DD</sub>	V
V <sub>IH</sub>	HIGH-level input voltage		0.7V <sub>DD</sub>	—	V <sub>DD</sub> + 0.5	V
ILI	Input leakage current	pin at V <sub>DD</sub> or V <sub>SS</sub>	-1	—	+1	μΑ
Ci	Input capacitance	$V_{I} = V_{SS}$	—	2	5	pF
Pass Gate	•	-				•
R <sub>ON</sub>	Switch resistance	$V_{CC}$ = 4.5 V to 5.5 V, $V_O$ = 0.4 V, $I_O$ = 15 mA	4	9	24	Ω
M	Quitab autoutualta na	$V_{swin} = V_{DD} = 5.0 \text{ V}; \text{ I}_{swout} = -100 \ \mu\text{A}$	—	3.6	—	V
V <sub>Pass</sub>	Switch output voltage	$V_{swin} = V_{DD} = 4.5 \text{ V}$ to 5.5 V; $I_{swout} = -100 \mu\text{A}$	2.6	-	4.5	V
١L	Leakage current	$V_{I} = V_{DD} \text{ or } V_{SS}$	-1	-	+1	μΑ
C <sub>io</sub>	Input/output capacitance	$V_{I} = V_{SS}$	—	3	5	pF
INT Output	•	-		•	•	-
I <sub>OL</sub>	LOW-level output current	V <sub>OL</sub> = 0.4 V	3	— —	- 1	mA
I <sub>ОН</sub>	HIGH-level output current		_	—	+10	μA

NOTES:

V<sub>DD</sub> must be lowered to 0.2 V in order to reset part.
 For operation between published voltage ranges, refer to worst case parameter in both ranges.

## PCA9544A

## **AC CHARACTERISTICS**

SYMBOL	PARAMETER		RD-MODE -bus	FAST-M I <sup>2</sup> C-b	UNIT	
		MIN	MAX	MIN	MAX	1
t <sub>pd</sub>	Propagation delay from SDA to SD <sub>n</sub> or SCL to SC <sub>n</sub>	—	0.3 <sup>1</sup>	—	0.3 <sup>1</sup>	ns
f <sub>SCL</sub>	SCL clock frequency	0	100	0	400	kHz
t <sub>BUF</sub>	Bus free time between a STOP and START condition	4.7	_	1.3	_	μs
t <sub>HD;STA</sub>	Hold time (repeated) START condition After this period, the first clock pulse is generated	4.0	_	0.6	_	μs
t <sub>LOW</sub>	LOW period of the SCL clock	4.7	- 1	1.3	_	μs
thigh	HIGH period of the SCL clock	4.0	_	0.6	_	μs
t <sub>SU;STA</sub>	Set-up time for a repeated START condition	4.7	_	0.6	—	μs
t <sub>SU;STO</sub>	Set-up time for STOP condition	4.0	_	0.6	—	μs
t <sub>HD;DAT</sub>	Data hold time	02	3.45	0 <sup>2</sup>	0.9	μs
t <sub>SU;DAT</sub>	Data set-up time	250	-	100	—	ns
t <sub>R</sub>	Rise time of both SDA and SCL signals	—	1000	$20 + 0.1 C_b^3$	300	ns
t <sub>F</sub>	Fall time of both SDA and SCL signals	—	300	$20 + 0.1 C_b^3$	300	μs
Cb	Capacitive load for each bus line	—	400	—	400	μs
t <sub>SP</sub>	Pulse width of spikes which must be suppressed by the input filter	_	50	—	50	ns
t <sub>VD:DATL</sub>	Data valid (HL) <sup>4</sup>	—	1	—	1	μs
t <sub>VD:DATH</sub>	Data valid (LH) <sup>4</sup>	—	0.6	—	0.6	μs
t <sub>VD:ACK</sub>	Data valid Acknowledge	—	1	—	1	μs
INT	•	-	•			-
t <sub>iv</sub>	INTn to INT active valid time <sup>4</sup>	—	4	—	4	μs
t <sub>ir</sub>	INTn to INT inactive delay time <sup>4</sup>	—	2	—	2	μs
L <sub>pwr</sub>	LOW level pulse width rejection of INTn inputs <sup>4</sup>	10	—	1	—	ns
H <sub>pwr</sub>	HIGH level pulse width rejection of INTn inputs <sup>4</sup>	500		500		ns

NOTES:

Pass gate propagation delay is calculated from the 20 Ω typical R<sub>ON</sub> and and the 15 pF load capacitance.
 A device must internally provide a hold time of at least 300ns for the SDA signal (referred to the V<sub>IH(min)</sub> of the SCL signal) in order to bridge the undefined region of the falling edge of SCL.
 C<sub>b</sub> = total capacitance of one bus line in pF.

4. Measurements taken with 1 kΩ pull-up resistor and 50 pF load.

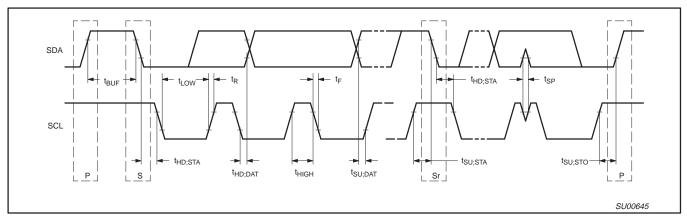
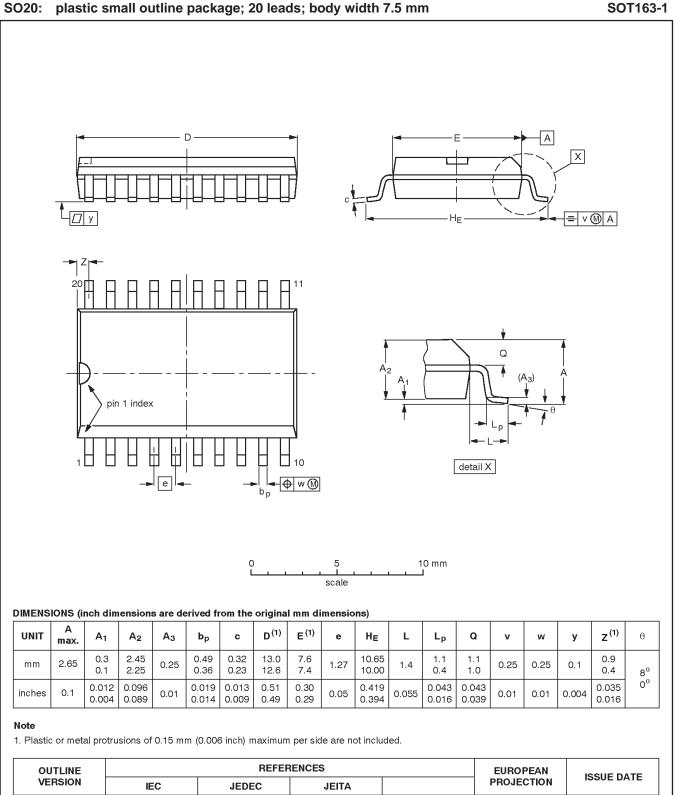


Figure 14. Definition of timing on the I<sup>2</sup>C-bus

SOT163-1

075E04

# 4-channel I<sup>2</sup>C multiplexer with interrupt logic



#### Product data sheet

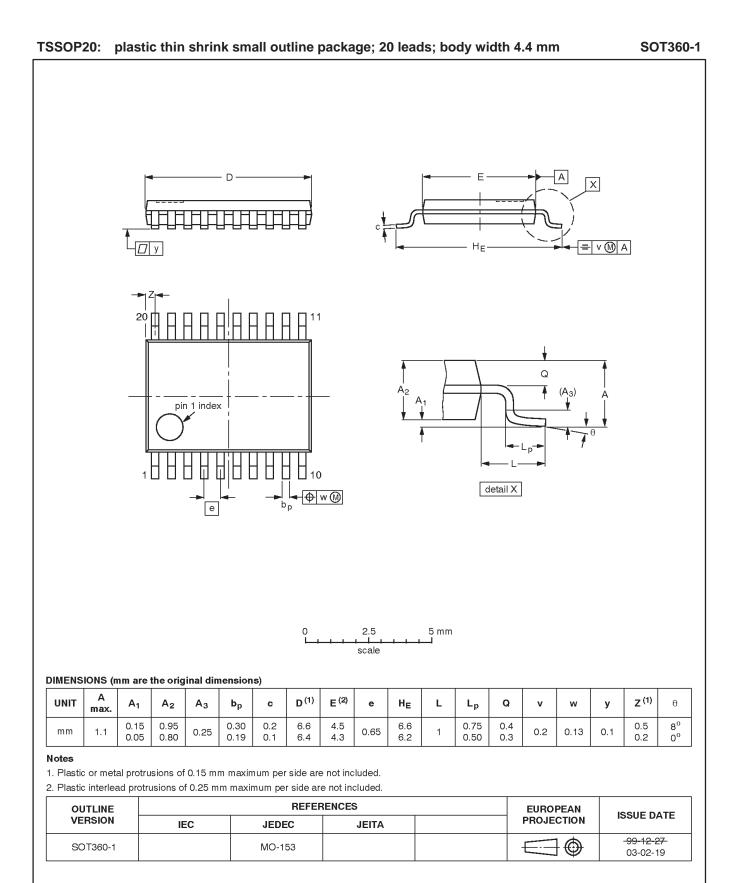
PCA9544A



<del>-99-12-27</del> 03-02-19

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E



#### Product data sheet

#### SOT662-1 В Α D terminal 1 index area F С detail X С e<sub>1</sub> // y1 C-ДУ е b-10 6 L 11 5 ⊃ Г ÷ С е Ėh e<sub>2</sub> $\supset$ E 1 $\square$ ÷ 15 n n terminal 1 20 16 index area Х -D<sub>h</sub>-0 2.5 5 mm scale DIMENSIONS (mm are the original dimensions) A<sup>(1)</sup> D<sup>(1)</sup> UNIT E<sup>(1)</sup> A<sub>1</sub> b С Dh Eh е L v w У e1 e2 У1 max. 0.05 0.38 5.1 3.25 5.1 3.25 0.75 0.65 0.05 mm 1 0.2 2.6 2.6 0.1 0.05 0.1 0.00 0.23 4.9 2.95 4.9 2.95 0.50 Note 1. Plastic or metal protrusions of 0.075 mm maximum per side are not included. REFERENCES OUTLINE EUROPEAN ISSUE DATE VERSION PROJECTION JEDEC IEC JEITA

## HVQFN20: plastic thermal enhanced very thin quad flat package; no leads; 20 terminals; body 5 x 5 x 0.85 mm

01-08-08  $\odot$ SOT662-1 - - -MO-220 - - -E 02-10-22

## **REVISION HISTORY**

Rev	Date	Description
_2	Date 2004929	<ul> <li>Product data sheet (9397 750 13931). Supersedes data of 2004 Jul 28 (9397 750 13301).</li> <li>Modifications:</li> <li>Table 1. "Control Register; Write — Channel Selection / Read — Channel Status" on page 5: add 'no channel selected; power-up default state' row to bottom of table</li> <li>DC characteristics table (V<sub>DD</sub> = 2.3 V to 3.6 V) on page 11: <ul> <li>Supply</li> <li>change I<sub>DD</sub> Typ. from 20 µA to 10 µA</li> <li>change I<sub>DD</sub> Max. from 50 µA to 30 µA</li> <li>Input SCL; input/output SDA</li> <li>change I<sub>OL</sub> Typ. (V<sub>OL</sub> = 0.4 V) from "–" to 7 mA</li> <li>change I<sub>OL</sub> Typ. (V<sub>OL</sub> = 0.6 V) from "–" to 10 mA</li> </ul> </li> </ul>
		<ul> <li>change C<sub>i</sub> Typ. from 12 pF to 10 pF</li> <li>Select inputs A0 to A2 / INT0 to INT3</li> <li>change Test conditions for I<sub>L1</sub> from "pin at V<sub>DD</sub> or V<sub>SS</sub>" to "V<sub>I</sub> = V<sub>DD</sub> or V<sub>SS</sub>"</li> <li>INT output</li> <li>change I<sub>OL</sub> Typ. from "-" to 7 mA</li> <li>change I<sub>OH</sub> Max. from +100 µA to +10 µA</li> <li>Add Note 2.</li> </ul>
		<ul> <li>DC characteristics table (V<sub>DD</sub> = 4.5 V to 5.5 V) on page 12:</li> <li>change description from "V<sub>DD</sub> = 3.6 V to 5.5 V" to "V<sub>DD</sub> = 4.5 V to 5.5 V"</li> <li>Supply</li> <li>change V<sub>DD</sub> Min. from 3.6 V to 4.5 V</li> <li>change I<sub>DD</sub> Typ. from 65 μA to 25 μA</li> <li>Input SCL; input/output SDA</li> <li>remove parameters I<sub>IL</sub> and I<sub>IH</sub></li> <li>add parameter I<sub>L</sub></li> <li>Select inputs A0 to A2 / INTO to INT3; change I<sub>L1</sub> Max. from +50 μA to +1 μA</li> <li>Pass Gate</li> <li>change I<sub>L</sub> Min. from -10 μA to -1 μA</li> <li>change I<sub>L</sub> Max. from +100 μA to +1 μA</li> <li>INT output; change I<sub>OH</sub> Max from +100 μA to +10 μA</li> <li>Add Note 2.</li> </ul>
		<ul> <li>AC characteristics table on page 13:         <ul> <li>add reference to (new) Note 4 at parameters t<sub>VD:DATL</sub> and t<sub>VD:DATH</sub></li> <li>INT</li> <li>Add reference to (new) Note 4 in all 4 parameter descriptions</li> <li>L<sub>pwr</sub> and H<sub>pwr</sub>: change "or" to "of"</li> <li>Add Note 4.</li> </ul> </li> </ul>
_1	20040728	Objective data sheet (9397 750 13301).

## PCA9544A



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